



## MU2G4A041-R module Engineering Change Notice



ECN_02_003		
ECN No.	Date	By

<b>FREESYSTEMS™</b>  Released Document <i>Company Confidential</i>	TITLE	2219M29 ECN		
	Document No.	ECN_02_003	Page 1 of 3	
	Created By	Siew CK		
	Approved By	Chan CO		
	Date	23 <sup>rd</sup> Oct 2012	Revision	1.0

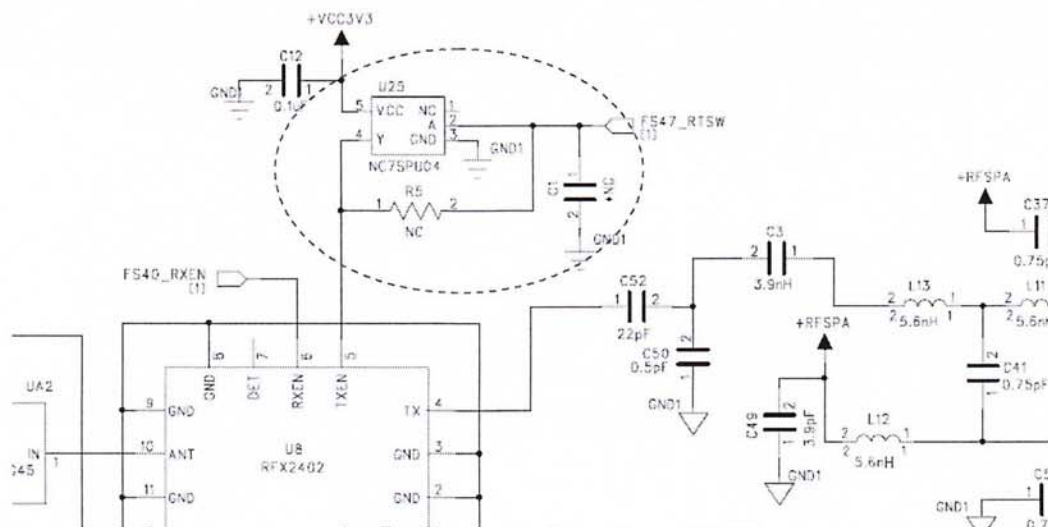
### Revision History

Revision	Change Reason	Date	By Who	Remarks
1.0	Improvement	23 <sup>rd</sup> Oct	Siew CK	

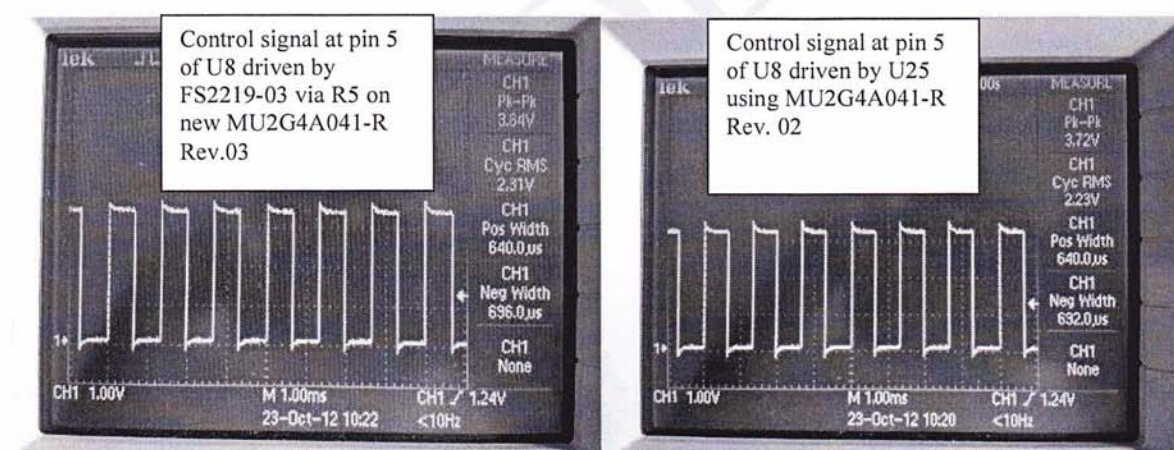
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<b>FREESYSTEMS™</b>		TITLE	2219M29 ECN		
Released Document <i>Company Confidential</i>		Document No.	ECN_02_003	Page 2 of 3	
		Created By	Siew CK		
		Approved By	Chan CO		
		Date	23 <sup>rd</sup> Oct 2012	Revision	1.0

This ECN is to inform that new **MU2G4A041-R, Rev. 03** module remove the extra inverter logic, U25 and replace with R5 zero Ohm resistor as show below



New FS2219-03 has absorbed the function of inverter into the IC to streamline the design



There is no functional or RF performance change due to this ECN and will not impact on the FCC qualification, FCC part 15.247 specifically for RF radiation standard of a product

The new chip component is compatible. The new chip has the same basic function as the old chip, and No change in radio parameters has occurred.

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		2219M29 ECN			
Released Document Company Confidential		Document No.	ECN_02_003	Page 3 of 3	
		Created By	Siew CK		
		Approved By	Chan CO		
		Date	23 <sup>rd</sup> Oct 2012	Revision	1.0

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*System solutions for digital audio*

## Letter of Guarantee

This is inform that the proposed new change of MU2G4A041-R, Rev. 03 module as described under the ECN\_02\_003, will not affect the qualification of FCC part 15.247, which is related to the RF radiation of a system  
The new chip component is compatible;  
The new chip has the same basic function as the old chip;  
No change in radio parameters has occurred.

**FreeSystems Pte. Ltd.**

Signature: \_\_\_\_\_



Name: Chan Chee Oei

Title: Director of Engineering

Date: 23-10-2012